### MINIATURE FAST RECOVERY RECTIFIER Reverse Voltage - 50 to 1000 V Forward Current - 1 A

#### **Features**

- · High current capability
- High reliability
- Low forward voltage drop
- Low leakage
- · High switching capability

#### **Mechanical Data**

• Case: Molded plastic, R-1

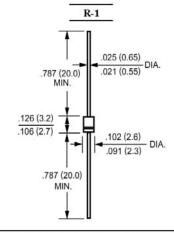
• Epoxy: UL 94V-0 rate flame retardant

• Lead: Axial leads, solderable per MIL-STD-202,

Method 208 guaranteed

• Polarity: color band denotes cathode end

• Mounting Position: Any



Dimensions in inches and (millimeters)

#### **Absolute Maximum Ratings and Characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	1F1	1F2	1F3	1F4	1F5	1F6	1F7	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current 0.375" (9.5 mm) Lead Length at $T_A = 55$ °C	I <sub>(AV)</sub>	1							Α
Peak Forward Surge Current, 8.3 ms Single Half- Sine-Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	25							А
Maximum Forward Voltage at 1 A DC	V <sub>F</sub>	1.3						V	
Maximum Reverse Current $T_A = 25 ^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_A = 100 ^{\circ}\text{C}$	I <sub>R</sub>	5 500							μА
Typical Junction Capacitance 1)	C	12							pF
Typical Thermal Resistance 2)	$R_{\theta JA}$	67							°C/W
Maximum Reverse Recovery Time 3)	t <sub>rr</sub>		15	50		250	50	00	nS
Operating and Storage Temperature Range	$T_{J,} T_{stg}$	- 55 to + 150							°C

<sup>1)</sup> Measured at 1 MHz and applied reverse voltage of 4 V DC.

 $<sup>^{3)}</sup>$  Reverse recovery test conditions:  $I_F = 0.5$  A,  $I_R = 1$  A,  $I_{rr} = 0.25$  A



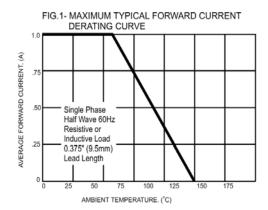
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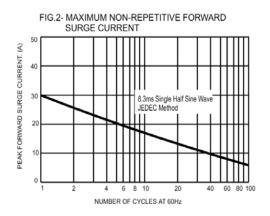
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Dated: 03/04/2007

<sup>&</sup>lt;sup>2)</sup> Thermal resistance from junction to ambient 0.375" (9.5 mm) lead length P.C.B. mounted with 0.22 X 0.22" (5.5 X 5.5 mm) copper pads.





Pulse Width=300µ 1% Duty Cycle FORWARD CURRENT. (A) 0.3 INSTANTANEOUS

FORWARD VOLTAGE. (V)

FIG.3- TYPICAL FORWARD CHARACTERISTICS

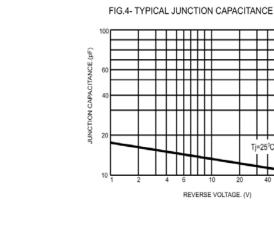
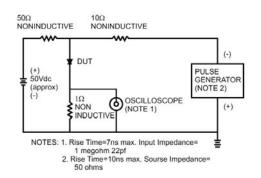
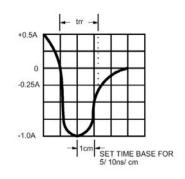


FIG.5- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM







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Ti=25°C



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